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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

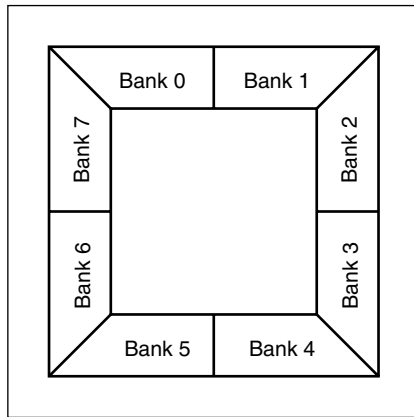
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

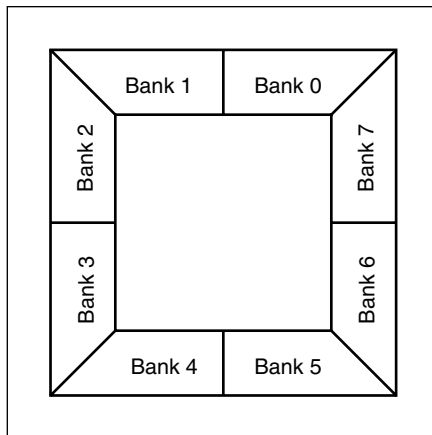
Product Status	Obsolete
Number of LABs/CLBs	768
Number of Logic Elements/Cells	-
Total RAM Bits	589824
Number of I/O	172
Number of Gates	500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v500-6fgg256c



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Figure 7: Virtex-II I/O Banks: Top View for Wire-Bond Packages (CS/CSG, FG/FGG, & BG/BGG)

Some input standards require a user-supplied threshold voltage (V_{REF}), and certain user I/O pins are automatically configured as V_{REF} inputs. Approximately one in six of the I/O pins in the bank assume this role.



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Figure 8: Virtex-II I/O Banks: Top View for Flip-Chip Packages (FF & BF)

V_{REF} pins within a bank are interconnected internally, and consequently only one V_{REF} voltage can be used within each bank. However, for correct operation, all V_{REF} pins in the bank must be connected to the external reference voltage source.

The V_{CCO} and the V_{REF} pins for each bank appear in the device pinout tables. Within a given package, the number of V_{REF} and V_{CCO} pins can vary depending on the size of device. In larger devices, more I/O pins convert to V_{REF} pins. Since these are always a superset of the V_{REF} pins used for smaller devices, it is possible to design a PCB that permits migration to a larger device if necessary.

All V_{REF} pins for the largest device anticipated must be connected to the V_{REF} voltage and not used for I/O. In smaller

devices, some V_{CCO} pins used in larger devices do not connect within the package. These unconnected pins can be left unconnected externally, or, if necessary, they can be connected to V_{CCO} to permit migration to a larger device.

Rules for Combining I/O Standards in the Same Bank

The following rules must be obeyed to combine different input, output, and bi-directional standards in the same bank:

1. **Combining output standards only.** Output standards with the same output V_{CCO} requirement can be combined in the same bank.

Compatible example:

SSTL2_I and LVDS_25_DCI outputs

Incompatible example:

SSTL2_I (output $V_{CCO} = 2.5V$) and LVCMOS33 (output $V_{CCO} = 3.3V$) outputs

2. **Combining input standards only.** Input standards with the same input V_{CCO} and input V_{REF} requirements can be combined in the same bank.

Compatible example:

LVCMOS15 and HSTL_IV inputs

Incompatible example:

LVCMOS15 (input $V_{CCO} = 1.5V$) and LVCMOS18 (input $V_{CCO} = 1.8V$) inputs

Incompatible example:

HSTL_I_DCI_18 ($V_{REF} = 0.9V$) and HSTL_IV_DCI_18 ($V_{REF} = 1.1V$) inputs

3. **Combining input standards and output standards.** Input standards and output standards with the same input V_{CCO} and output V_{CCO} requirement can be combined in the same bank.

Compatible example:

LVDS_25 output and HSTL_I input

Incompatible example:

LVDS_25 output (output $V_{CCO} = 2.5V$) and HSTL_I_DCI_18 input (input $V_{CCO} = 1.8V$)

4. **Combining bi-directional standards with input or output standards.** When combining bi-directional I/O with other standards, make sure the bi-directional standard can meet rules 1 through 3 above.
5. **Additional rules for combining DCI I/O standards.**

- a. No more than one Single Termination type (input or output) is allowed in the same bank.

Incompatible example:

HSTL_IV_DCI input and HSTL_III_DCI input

- b. No more than one Split Termination type (input or output) is allowed in the same bank.

Incompatible example:

HSTL_I_DCI input and HSTL_II_DCI input

The implementation tools will enforce these design rules.

Table 5 summarizes all standards and voltage supplies.

The Virtex-II implementation process is comprised of Synthesis, translation, mapping, place and route, and configuration file generation. While the tools can be run individually, many designers choose to run the entire implementation process with the click of a button. To assist those who prefer to script their design flows, Xilinx provides Xflow, an automated single command line process.

Design Verification

In addition to conventional design verification using static timing analysis or simulation techniques, Xilinx offers powerful in-circuit debugging techniques using ChipScope ILA (Integrated Logic Analysis). The reconfigurable nature of Xilinx FPGAs means that designs can be verified in real time without the need for extensive sets of software simulation vectors.

For simulation, the system extracts post-layout timing information from the design database, and back-annotates this information into the netlist for use by the simulator. The back annotation features a variety of patented Xilinx techniques, resulting in the industry's most powerful simulation flows. Alternatively, timing-critical portions of a design can be verified using the Xilinx static timing analyzer or a third party static timing analysis tool like Synopsys Prime Time™, by exporting timing data in the STAMP data format.

For in-circuit debugging, ChipScope ILA enables designers to analyze the real-time behavior of a device while operating at full system speeds. Logic analysis commands and captured data are transferred between the ChipScope software and ILA cores within the Virtex-II FPGA, using industry standard JTAG protocols. These JTAG transactions are driven over an optional download cable (MultiLINX or JTAG), connecting the Virtex device in the target system to a PC or workstation.

ChipScope ILA was designed to look and feel like a logic analyzer, making it easy to begin debugging a design immediately. Modifications to the desired logic analysis can be downloaded directly into the system in a matter of minutes.

Other Unique Features of Virtex-II Design Flow

Xilinx design flows feature a number of unique capabilities. Among these are efficient incremental HDL design flows; a

robust capability that is enabled by Xilinx exclusive hierarchical floorplanning capabilities. Another powerful design capability only available in the Xilinx design flow is "Modular Design", part of the Xilinx suite of team design tools, which enables autonomous design, implementation, and verification of design modules.

Incremental Synthesis

Xilinx unique hierarchical floorplanning capabilities enable designers to create a programmable logic design by isolating design changes within one hierarchical "logic block", and perform synthesis, verification and implementation processes on that specific logic block. By preserving the logic in unchanged portions of a design, Xilinx incremental design makes the high-density design process more efficient.

Xilinx hierarchical floorplanning capabilities can be specified using the high-level floorplanner or a preferred RTL floorplanner (see the Xilinx web site for a list of supported EDA partners). When used in conjunction with one of the EDA partners' floorplanners, higher performance results can be achieved, as many synthesis tools use this more predictable detailed physical implementation information to establish more aggressive and accurate timing estimates when performing their logic optimizations.

Modular Design

Xilinx innovative modular design capabilities take the incremental design process one step further by enabling the designer to delegate responsibility for completing the design, synthesis, verification, and implementation of a hierarchical "logic block" to an arbitrary number of designers - assigning a specific region within the target FPGA for exclusive use by each of the team members.

This team design capability enables an autonomous approach to design modules, changing the hand-off point to the lead designer or integrator from "my module works in simulation" to "my module works in the FPGA". This unique design methodology also leverages the Xilinx hierarchical floorplanning capabilities and enables the Xilinx (or EDA partner) floorplanner to manage the efficient implementation of very high-density FPGAs.

Virtex-II Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Virtex-II devices. The numbers reported here are worst-case values; they have all been fully characterized. Note that these values are subject to the same guidelines as [Virtex-II Switching Characteristics, page 9](#) (speed files).

Table 11 provides pin-to-pin values (in nanoseconds) including IOB delays; that is, delay through the device from input pin to output pin. In the case of multiple inputs and outputs, the worst delay is reported.

Table 11: Pin-to-Pin Performance

Description	Device Used & Speed Grade	Pin-to-Pin (with I/O delays)	Units
Basic Functions			
16-bit Address Decoder	XC2V1000 -5	6.3	ns
32-bit Address Decoder	XC2V1000 -5	7.7	ns
64-bit Address Decoder	XC2V1000 -5	9.3	ns
4:1 MUX	XC2V1000 -5	5.7	ns
8:1 MUX	XC2V1000 -5	6.5	ns
16:1 MUX	XC2V1000 -5	6.7	ns
32:1 MUX	XC2V1000 -5	8.7	ns
Combinatorial (pad to LUT to pad)	XC2V1000 -5	5.0	ns
Memory			
Block RAM			
Pad to setup		1.6	ns
Clock to Pad		9.5	ns
Distributed RAM			
Pad to setup	XC2V1000 -5	2.7	ns
Clock to Pad	XC2V1000 -5	5.1 (no clk skew)	ns

Table 12 shows internal (register-to-register) performance. Values are reported in MHz.

Table 12: Register-to-Register Performance

Description	Device Used & Speed Grade	Register-to-Register Performance	Units
Basic Functions			
16-bit Address Decoder	XC2V1000 -5	398	MHz
32-bit Address Decoder	XC2V1000 -5	291	MHz
64-bit Address Decoder	XC2V1000 -5	274	MHz
4:1 MUX	XC2V1000 -5	563	MHz
8:1 MUX	XC2V1000 -5	454	MHz
16:1 MUX	XC2V1000 -5	414	MHz
32:1 MUX	XC2V1000 -5	323	MHz
Register to LUT to Register	XC2V1000 -5	613	MHz

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
7	IO_L45N_7	F5	NC	NC
7	IO_L43P_7	F1	NC	NC
7	IO_L43N_7	F2	NC	NC
7	IO_L06P_7	F3	NC	
7	IO_L06N_7	F4	NC	
7	IO_L04P_7	E1	NC	
7	IO_L04N_7	E2	NC	
7	IO_L03P_7/VREF_7	E3		
7	IO_L03N_7	E4		
7	IO_L02P_7/VRN_7	D2		
7	IO_L02N_7/VRP_7	D3		
7	IO_L01P_7	D1		
7	IO_L01N_7	C1		
0	VCCO_0	F8		
0	VCCO_0	F7		
0	VCCO_0	E8		
1	VCCO_1	F10		
1	VCCO_1	F9		
1	VCCO_1	E9		
2	VCCO_2	H12		
2	VCCO_2	H11		
2	VCCO_2	G11		
3	VCCO_3	K11		
3	VCCO_3	J12		
3	VCCO_3	J11		
4	VCCO_4	M9		
4	VCCO_4	L10		
4	VCCO_4	L9		
5	VCCO_5	M8		
5	VCCO_5	L8		
5	VCCO_5	L7		
6	VCCO_6	K6		
6	VCCO_6	J6		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
6	IO_L46P_6	R2		
6	IO_L46N_6	R1		
6	IO_L48P_6	P6		
6	IO_L48N_6	P5		
6	IO_L49P_6	P4	NC	
6	IO_L49N_6	P3	NC	
6	IO_L51P_6	P2	NC	
6	IO_L51N_6/VREF_6	P1	NC	
6	IO_L52P_6	N6	NC	
6	IO_L52N_6	N5	NC	
6	IO_L54P_6	N4	NC	
6	IO_L54N_6	N3	NC	
6	IO_L91P_6	N2		
6	IO_L91N_6	N1		
6	IO_L93P_6	M6		
6	IO_L93N_6/VREF_6	M5		
6	IO_L94P_6	M4		
6	IO_L94N_6	M3		
6	IO_L96P_6	M2		
6	IO_L96N_6	M1		
7	IO_L96P_7	L2		
7	IO_L96N_7	L3		
7	IO_L94P_7	L4		
7	IO_L94N_7	L5		
7	IO_L93P_7/VREF_7	K1		
7	IO_L93N_7	K2		
7	IO_L91P_7	K3		
7	IO_L91N_7	K4		
7	IO_L54P_7	L6	NC	
7	IO_L54N_7	K6	NC	
7	IO_L52P_7	K5	NC	
7	IO_L52N_7	J5	NC	
7	IO_L51P_7/VREF_7	J1	NC	

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
1	IO_L92P_1	A15		
1	IO_L91N_1	B15		
1	IO_L91P_1/VREF_1	C15		
1	IO_L78N_1	D15	NC	
1	IO_L78P_1	E15	NC	
1	IO_L76N_1	F15	NC	
1	IO_L76P_1	G15	NC	
1	IO_L75N_1/VREF_1	G16	NC	
1	IO_L75P_1	F16	NC	
1	IO_L73N_1	A16	NC	
1	IO_L73P_1	A17	NC	
1	IO_L72N_1	B16		
1	IO_L72P_1	C16		
1	IO_L70N_1	D16		
1	IO_L70P_1	E16		
1	IO_L69N_1/VREF_1	C17		
1	IO_L69P_1	D17		
1	IO_L67N_1	H16		
1	IO_L67P_1	G17		
1	IO_L54N_1	E17		
1	IO_L54P_1	F17		
1	IO_L52N_1	A18		
1	IO_L52P_1	A19		
1	IO_L51N_1/VREF_1	E18		
1	IO_L51P_1	D18		
1	IO_L49N_1	B18		
1	IO_L49P_1	C18		
1	IO_L27N_1/VREF_1	F19	NC	NC
1	IO_L27P_1	F18	NC	NC
1	IO_L25N_1	G18	NC	NC
1	IO_L25P_1	G19	NC	NC
1	IO_L24N_1	B19		
1	IO_L24P_1	C19		
1	IO_L22N_1	D19		
1	IO_L22P_1	E19		
1	IO_L21N_1/VREF_1	A20		
1	IO_L21P_1	A21		

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
4	IO_L91P_4	AB14		
4	IO_L92N_4	V14		
4	IO_L92P_4	Y14		
4	IO_L93N_4	AB13		
4	IO_L93P_4	AC13		
4	IO_L94N_4/VREF_4	Y13		
4	IO_L94P_4	AA13		
4	IO_L95N_4/GCLK3S	V13		
4	IO_L95P_4/GCLK2P	W13		
4	IO_L96N_4/GCLK1S	U14		
4	IO_L96P_4/GCLK0P	U13		
5	IO_L96N_5/GCLK7S	AD12		
5	IO_L96P_5/GCLK6P	AD11		
5	IO_L95N_5/GCLK5S	AC12		
5	IO_L95P_5/GCLK4P	AB12		
5	IO_L94N_5	AA12		
5	IO_L94P_5/VREF_5	Y12		
5	IO_L93N_5	W12		
5	IO_L93P_5	V12		
5	IO_L92N_5	U12		
5	IO_L92P_5	U11		
5	IO_L91N_5	AB11		
5	IO_L91P_5/VREF_5	AA11		
5	IO_L73N_5	Y11	NC	NC
5	IO_L73P_5	V11	NC	NC
5	IO_L72N_5	AD10	NC	
5	IO_L72P_5	AD9	NC	
5	IO_L70N_5	AC10	NC	
5	IO_L70P_5	AB10	NC	
5	IO_L69N_5/VREF_5	Y10	NC	
5	IO_L69P_5	W10	NC	
5	IO_L67N_5	V10	NC	
5	IO_L67P_5	U10	NC	
5	IO_L54N_5	AC9		
5	IO_L54P_5	AB9		

BG728/BGG728 Standard BGA Package

As shown in Table 10, XC2V3000 Virtex-II devices are available in the BG728/BGG728 BGA package. Following this table are the **BG728/BGG728 Standard BGA Package Specifications (1.27mm pitch)**.

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
0	IO_L01N_0	B3
0	IO_L01P_0	A3
0	IO_L02N_0	B4
0	IO_L02P_0	A4
0	IO_L03N_0/VRP_0	C5
0	IO_L03P_0/VRN_0	C6
0	IO_L04N_0/VREF_0	B5
0	IO_L04P_0	A5
0	IO_L05N_0	E6
0	IO_L05P_0	D6
0	IO_L06N_0	B6
0	IO_L06P_0	A6
0	IO_L19N_0	E7
0	IO_L19P_0	D8
0	IO_L21N_0	F8
0	IO_L21P_0/VREF_0	E8
0	IO_L22N_0	C7
0	IO_L22P_0	C8
0	IO_L24N_0	B7
0	IO_L24P_0	A7
0	IO_L25N_0	H9
0	IO_L25P_0	J9
0	IO_L27N_0	F9
0	IO_L27P_0/VREF_0	G9
0	IO_L28N_0	E9
0	IO_L28P_0	D9
0	IO_L30N_0	C9
0	IO_L30P_0	B9
0	IO_L49N_0	A8
0	IO_L49P_0	A9
0	IO_L51N_0	G10
0	IO_L51P_0/VREF_0	H10
0	IO_L52N_0	F10

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
2	IO_L70P_2	N19
2	IO_L72N_2	M22
2	IO_L72P_2	M23
2	IO_L73N_2	M24
2	IO_L73P_2	N24
2	IO_L75N_2	M26
2	IO_L75P_2/VREF_2	M27
2	IO_L76N_2	N20
2	IO_L76P_2	N21
2	IO_L78N_2	N22
2	IO_L78P_2	N23
2	IO_L91N_2	N25
2	IO_L91P_2	P25
2	IO_L93N_2	N26
2	IO_L93P_2/VREF_2	N27
2	IO_L94N_2	P20
2	IO_L94P_2	P21
2	IO_L96N_2	P22
2	IO_L96P_2	P23
3	IO_L96N_3	R27
3	IO_L96P_3	R26
3	IO_L94N_3	R25
3	IO_L94P_3	R24
3	IO_L93N_3/VREF_3	R23
3	IO_L93P_3	T23
3	IO_L91N_3	R22
3	IO_L91P_3	R21
3	IO_L78N_3	R20
3	IO_L78P_3	R19
3	IO_L76N_3	T27
3	IO_L76P_3	T26
3	IO_L75N_3/VREF_3	T24
3	IO_L75P_3	U24
3	IO_L73N_3	T22
3	IO_L73P_3	U22

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
4	IO_L27P_4/VREF_4	AG19
4	IO_L28N_4	AB19
4	IO_L28P_4	AA19
4	IO_L30N_4	AC19
4	IO_L30P_4	AD19
4	IO_L49N_4	AE19
4	IO_L49P_4	AF19
4	IO_L51N_4	AA18
4	IO_L51P_4/VREF_4	Y18
4	IO_L52N_4	AB18
4	IO_L52P_4	AC18
4	IO_L54N_4	AD18
4	IO_L54P_4	AE18
4	IO_L67N_4	AF18
4	IO_L67P_4	AG18
4	IO_L69N_4	AA17
4	IO_L69P_4/VREF_4	Y17
4	IO_L70N_4	AB17
4	IO_L70P_4	AB16
4	IO_L72N_4	AD17
4	IO_L72P_4	AE17
4	IO_L73N_4	AF17
4	IO_L73P_4	AG17
4	IO_L75N_4	Y16
4	IO_L75P_4/VREF_4	W16
4	IO_L76N_4	AC16
4	IO_L76P_4	AD16
4	IO_L78N_4	AF16
4	IO_L78P_4	AG16
4	IO_L91N_4/VREF_4	W15
4	IO_L91P_4	Y15
4	IO_L92N_4	AB15
4	IO_L92P_4	AA15
4	IO_L93N_4	AC15
4	IO_L93P_4	AD15
4	IO_L94N_4/VREF_4	AE15

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
6	IO_L52N_6	V3
6	IO_L54P_6	V2
6	IO_L54N_6	V1
6	IO_L67P_6	U8
6	IO_L67N_6	T8
6	IO_L69P_6	U6
6	IO_L69N_6/VREF_6	U7
6	IO_L70P_6	U4
6	IO_L70N_6	U3
6	IO_L72P_6	U2
6	IO_L72N_6	U1
6	IO_L73P_6	T9
6	IO_L73N_6	R9
6	IO_L75P_6	T5
6	IO_L75N_6/VREF_6	T6
6	IO_L76P_6	T4
6	IO_L76N_6	R4
6	IO_L78P_6	T2
6	IO_L78N_6	T1
6	IO_L91P_6	R7
6	IO_L91N_6	R8
6	IO_L93P_6	R5
6	IO_L93N_6/VREF_6	R6
6	IO_L94P_6	R3
6	IO_L94N_6	P3
6	IO_L96P_6	R2
6	IO_L96N_6	R1
7	IO_L96P_7	P5
7	IO_L96N_7	P6
7	IO_L94P_7	P7
7	IO_L94N_7	P8
7	IO_L93P_7/VREF_7	N1
7	IO_L93N_7	N2
7	IO_L91P_7	N3
7	IO_L91N_7	N4

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
7	IO_L78P_7	N6
7	IO_L78N_7	N7
7	IO_L76P_7	N9
7	IO_L76N_7	N8
7	IO_L75P_7/VREF_7	N5
7	IO_L75N_7	M6
7	IO_L73P_7	M1
7	IO_L73N_7	M2
7	IO_L72P_7	M4
7	IO_L72N_7	M5
7	IO_L70P_7	M8
7	IO_L70N_7	M9
7	IO_L69P_7/VREF_7	L1
7	IO_L69N_7	L2
7	IO_L67P_7	L3
7	IO_L67N_7	L4
7	IO_L54P_7	K1
7	IO_L54N_7	K2
7	IO_L52P_7	K4
7	IO_L52N_7	K5
7	IO_L51P_7/VREF_7	L6
7	IO_L51N_7	L7
7	IO_L49P_7	K6
7	IO_L49N_7	K7
7	IO_L48P_7	L8
7	IO_L48N_7	K8
7	IO_L46P_7	J1
7	IO_L46N_7	H1
7	IO_L45P_7/VREF_7	J2
7	IO_L45N_7	J3
7	IO_L43P_7	K3
7	IO_L43N_7	J4
7	IO_L30P_7	H3
7	IO_L30N_7	H4
7	IO_L28P_7	J5
7	IO_L28N_7	J6

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L29P_6	AF31	
6	IO_L29N_6	AG31	
6	IO_L30P_6	AF32	
6	IO_L30N_6	AG32	
6	IO_L43P_6	AC25	
6	IO_L43N_6	AB25	
6	IO_L44P_6	AJ33	
6	IO_L44N_6	AH33	
6	IO_L45P_6	AE31	
6	IO_L45N_6/VREF_6	AD32	
6	IO_L46P_6	AD27	
6	IO_L46N_6	AC27	
6	IO_L47P_6	AJ34	
6	IO_L47N_6	AH34	
6	IO_L48P_6	AE30	
6	IO_L48N_6	AD30	
6	IO_L49P_6	AC26	
6	IO_L49N_6	AB26	
6	IO_L50P_6	AD29	
6	IO_L50N_6	AC29	
6	IO_L51P_6	AF33	
6	IO_L51N_6/VREF_6	AG33	
6	IO_L52P_6	AC28	
6	IO_L52N_6	AB28	
6	IO_L53P_6	AF34	
6	IO_L53N_6	AE33	
6	IO_L54P_6	AB27	
6	IO_L54N_6	AA27	
6	IO_L67P_6	AA25	
6	IO_L67N_6	Y25	
6	IO_L68P_6	AD33	
6	IO_L68N_6	AC33	
6	IO_L69P_6	AC32	
6	IO_L69N_6/VREF_6	AB32	
6	IO_L70P_6	AA26	
6	IO_L70N_6	Y26	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L09N_1/VREF_1	G9	NC	
1	IO_L09P_1	G10	NC	
1	IO_L08N_1	K13	NC	
1	IO_L08P_1	K12	NC	
1	IO_L07N_1	A4	NC	
1	IO_L07P_1	A5	NC	
1	IO_L06N_1	F8		
1	IO_L06P_1	E8		
1	IO_L05N_1	J11		
1	IO_L05P_1	K11		
1	IO_L04N_1	C5		
1	IO_L04P_1/VREF_1	C6		
1	IO_L03N_1/VRP_1	D6		
1	IO_L03P_1/VRN_1	D7		
1	IO_L02N_1	H10		
1	IO_L02P_1	J10		
1	IO_L01N_1	C4		
1	IO_L01P_1	B4		
2	IO_L01N_2	E3		
2	IO_L01P_2	D2		
2	IO_L02N_2/VRP_2	L13		
2	IO_L02P_2/VRN_2	M13		
2	IO_L03N_2	F4		
2	IO_L03P_2/VREF_2	E4		
2	IO_L04N_2	E1		
2	IO_L04P_2	D1		
2	IO_L05N_2	L12		
2	IO_L05P_2	M11		
2	IO_L06N_2	G6		
2	IO_L06P_2	F5		
2	IO_L07N_2	F2	NC	
2	IO_L07P_2	E2	NC	
2	IO_L08N_2	M12	NC	
2	IO_L08P_2	N12	NC	
2	IO_L09N_2	H6	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
3	IO_L58N_3	AD5		
3	IO_L58P_3	AE5		
3	IO_L57N_3/VREF_3	AE11		
3	IO_L57P_3	AD11		
3	IO_L56N_3	AG1		
3	IO_L56P_3	AH1		
3	IO_L55N_3	AD6		
3	IO_L55P_3	AE6		
3	IO_L54N_3	AF10		
3	IO_L54P_3	AE10		
3	IO_L53N_3	AG2		
3	IO_L53P_3	AH2		
3	IO_L52N_3	AF4		
3	IO_L52P_3	AG4		
3	IO_L51N_3/VREF_3	AG8		
3	IO_L51P_3	AF8		
3	IO_L50N_3	AH3		
3	IO_L50P_3	AJ3		
3	IO_L49N_3	AE7		
3	IO_L49P_3	AF7		
3	IO_L48N_3	AG9		
3	IO_L48P_3	AF9		
3	IO_L47N_3	AF6		
3	IO_L47P_3	AG6		
3	IO_L46N_3	AG5		
3	IO_L46P_3	AH5		
3	IO_L45N_3/VREF_3	AF12		
3	IO_L45P_3	AE12		
3	IO_L44N_3	AJ1		
3	IO_L44P_3	AK1		
3	IO_L43N_3	AH4		
3	IO_L43P_3	AJ4		
3	IO_L36N_3	AG11	NC	
3	IO_L36P_3	AF11	NC	
3	IO_L35N_3	AK2	NC	
3	IO_L35P_3	AL2	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	IO_L47N_6	AJ39		
6	IO_L48P_6	AG35		
6	IO_L48N_6	AH35		
6	IO_L49P_6	AG32		
6	IO_L49N_6	AF32		
6	IO_L50P_6	AH37		
6	IO_L50N_6	AG37		
6	IO_L51P_6	AD29		
6	IO_L51N_6/VREF_6	AE29		
6	IO_L52P_6	AD28		
6	IO_L52N_6	AC28		
6	IO_L53P_6	AH38		
6	IO_L53N_6	AG38		
6	IO_L54P_6	AF34		
6	IO_L54N_6	AG34		
6	IO_L55P_6	AE32		
6	IO_L55N_6	AD32		
6	IO_L56P_6	AH39		
6	IO_L56N_6	AG39		
6	IO_L57P_6	AE33		
6	IO_L57N_6/VREF_6	AF33		
6	IO_L58P_6	AD30		
6	IO_L58N_6	AC30		
6	IO_L59P_6	AF37		
6	IO_L59N_6	AE37		
6	IO_L60P_6	AF36		
6	IO_L60N_6	AG36		
6	IO_L67P_6	AD31		
6	IO_L67N_6	AC31		
6	IO_L68P_6	AE34		
6	IO_L68N_6	AD34		
6	IO_L69P_6	AD35		
6	IO_L69N_6/VREF_6	AE35		
6	IO_L70P_6	AB28		
6	IO_L70N_6	AA28		
6	IO_L71P_6	AF39		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	Y17		
NA	GND	Y16		
NA	GND	Y10		
NA	GND	Y7		
NA	GND	Y4		
NA	GND	Y1		
NA	GND	W24		
NA	GND	W23		
NA	GND	W22		
NA	GND	W21		
NA	GND	W20		
NA	GND	W19		
NA	GND	W18		
NA	GND	W17		
NA	GND	W16		
NA	GND	V24		
NA	GND	V23		
NA	GND	V22		
NA	GND	V21		
NA	GND	V20		
NA	GND	V19		
NA	GND	V18		
NA	GND	V17		
NA	GND	V16		
NA	GND	U36		
NA	GND	U32		
NA	GND	U24		
NA	GND	U23		
NA	GND	U22		
NA	GND	U21		
NA	GND	U20		
NA	GND	U19		
NA	GND	U18		
NA	GND	U17		
NA	GND	U16		
NA	GND	U8		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
1	IO_L21P_1	A4	
1	IO_L20N_1	G10	
1	IO_L20P_1	G9	
1	IO_L19N_1	B6	
1	IO_L19P_1	C5	
1	IO_L06N_1	C6	
1	IO_L06P_1	D6	
1	IO_L05N_1	H9	
1	IO_L05P_1	G8	
1	IO_L04N_1	D7	
1	IO_L04P_1/VREF_1	E6	
1	IO_L03N_1/VRP_1	E8	
1	IO_L03P_1/VRN_1	E7	
1	IO_L02N_1	F8	
1	IO_L02P_1	F7	
1	IO_L01N_1	B5	
1	IO_L01P_1	B3	
2	IO_L01N_2	F5	
2	IO_L01P_2	G4	
2	IO_L02N_2/VRP_2	G6	
2	IO_L02P_2/VRN_2	H6	
2	IO_L03N_2	D3	
2	IO_L03P_2/VREF_2	E4	
2	IO_L04N_2	K10	
2	IO_L04P_2	K9	
2	IO_L05N_2	D2	
2	IO_L05P_2	E3	
2	IO_L06N_2	F4	
2	IO_L06P_2	F3	
2	IO_L19N_2	L10	
2	IO_L19P_2	M10	
2	IO_L20N_2	H7	
2	IO_L20P_2	J8	
2	IO_L21N_2	D1	
2	IO_L21P_2/VREF_2	E1	
2	IO_L22N_2	G5	
2	IO_L22P_2	H5	

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
4	IO_L29N_4	AL6	NC
4	IO_L29P_4	AL7	NC
4	IO_L30N_4	AJ9	NC
4	IO_L30P_4	AJ10	NC
4	IO_L49N_4	AE11	
4	IO_L49P_4	AE12	
4	IO_L50N_4	AG10	
4	IO_L50P_4	AG11	
4	IO_L51N_4	AL8	
4	IO_L51P_4/VREF_4	AL9	
4	IO_L52N_4	AF12	
4	IO_L52P_4	AF13	
4	IO_L53N_4	AK9	
4	IO_L53P_4	AK10	
4	IO_L54N_4	AH11	
4	IO_L54P_4	AH12	
4	IO_L67N_4	AC12	
4	IO_L67P_4	AC13	
4	IO_L68N_4	AG12	
4	IO_L68P_4	AG13	
4	IO_L69N_4	AL10	
4	IO_L69P_4/VREF_4	AL11	
4	IO_L70N_4	AD13	
4	IO_L70P_4	AD15	
4	IO_L71N_4	AJ11	
4	IO_L71P_4	AJ12	
4	IO_L72N_4	AK11	
4	IO_L72P_4	AK12	
4	IO_L73N_4	AE14	
4	IO_L73P_4	AE15	
4	IO_L74N_4	AF14	
4	IO_L74P_4	AF15	
4	IO_L75N_4	AL12	
4	IO_L75P_4/VREF_4	AL13	
4	IO_L76N_4	AB14	
4	IO_L76P_4	AC14	
4	IO_L77N_4	AH13	
4	IO_L77P_4	AH14	